

LINEAR TECHNOLOGY MATERIALS DECLARATION

1t3024ife#pbf

(Engineering Calculation)

TSSOP Exp. Pad

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TOTAL MASS (g) : 0.067339

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.003515	1000000	52198.6445312		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.025576	975000	379810.09375		
		Iron (Fe)	7439-89-6	0.000630	24000	9355.66015625		
		Phosphorus (P)	7723-14-0	0.000008	300	118.802032471		
		Zinc (Zn)	7440-66-6	0.000018	700	267.304595947		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.026232	1000000	389551.875		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.002364	1000000	35104.6640625		
		External Plating Total:				0.002364	1000000	35104.6640625
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.001030	1000000	15295.7626953		
Internal Plating Total:				0.001030	1000000	15295.7626953		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.001034	750000	15355.1621094		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000345	250000	5123.33789062		
Die Attach Total:				0.001379	1000000	20478.5019531		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.004875	150000	72394.9921875		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.026650	820000	395759.28125		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000813	25000	12073.2568359		
		Carbon Black (C)	1333-86-4	0.000163	5000	2420.59130859		
		Encapsulation Total:				0.032501	1000000	482648.125
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000318	1000000	4722.38085938		
					TOTAL MASS (g) :	0.067339		